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CLAIMS

- Polycrystalline gallium nitride (GaN), wherein the atomic fraction of gallium ranges from between about 49% to 55%, an apparent density of between about 5.5 and 6.1 g/cm³, and a Vickers hardness of above about 1 GPa.
- The GaN of claim 1, which has a thickness or minimum dimension of between about 0.2 mm and 1 m.
 - The GaN of claim 1, which has a diameter or maximum dimension of between about 1 mm and 1 m.
 - between about 1 mm and 1 m.
 - 4. The GaN of claim 1, which has equiaxed grains with an average size of between about 0.01 and 50 μm

 - The GaN of claim 5, having surfaces that are substantially smooth, with a root-mean-square roughness below about 20 μm.
- A method for making sintered polycrystalline gallium nitride (GaN), which comprises the steps of:
 - enclosing and sealing GaN as one or more of powder or a coldpressed bill, in a non-metallic container:
 - (b) subjecting said container to hot isostatic pressing (HIPing) at a temperature ranging from about 1150° C to 1300° C and a pressure ranging from between about 1 and 10 Kbar; and
 - (c) recovering polycrystalline GaN from said container.
- The method of claim 7, wherein said non-metallic container is evacuated of air prior to sealing.
 - The method of claim 7, wherein said HIPing is conducted for a time ranging from about 2 minutes to about 24 hours.
- 35 10. The method of claim 7, wherein said recovering step includes grinding off the container from said sintered polycrystalline GaN.

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- The method of claim 7, wherein said sintered polycrystalline GaN has a thickness or minimum dimension of between about 0.2 mm and 1 m.
- 5 12. The method of claim 7, wherein said sintered polycrystalline GaN has a diameter or maximum dimension of between about 1 mm and 1 m.
 - The method of claim 7, wherein said sintered polycrystalline GaN has equiaxed grains with an average size of between about 0.01 and 50 μm.
 - 14. The method of claim 7, wherein said sintered polycrystalline GaN has surfaces, which are substantially smooth, with a root-mean-square roughness below about 100 μm.
- 15 15. The method of claim 14, wherein said sintered polycrystalline GaN has surfaces, which are substantially smooth, with a root-mean-square roughness below about 20 um.
 - The method of claim 7, wherein said GaN enclosed in said container is a powder.
 - The method of claim 7, wherein said GaN enclosed in said container is a cold-pressed pill.
- 25 18. A method for making sintered polycrystalline gallium nitride (GaN), which comprises the steps of:
 - placing GaN as one or more of powder or a cold-pressed pill in a high pressure/high temperature (HP/HT) reaction cell;
 - (b) placing said reaction cell in a HP/HT apparatus;
 - (c) subjecting said container to a temperature ranging from about 1200° to 1800° C and a pressure ranging from about 5 to 80 Kbar, and
 - (d) recovering polycrystalline GaN from said reaction cell.
- 35 19. The method of claim 18, wherein step (c) is conducted for a time ranging from about 2 minutes to about 24 hours.

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- 20. The method of claim 18, wherein said recovering step includes grinding.
- The method of claim 18, wherein said sintered polycrystalline GaN has a thickness or minimum dimension of between about 0.2 mm and 1 m.

22. The method of claim 18, wherein said sintered polycrystalline GaN has a diameter or maximum dimension of between about 1 mm and 1 m

- The method of claim 18, wherein said sintered polycrystalline GaN has equiaxed grains with an average size of between about 0.01 and 50 μm.
 - 24. The method of claim 18, wherein said sintered polycrystalline GaN has surfaces, which are substantially smooth, with a root-mean-square roughness below about 100 μm.
 - The method of claim 24, wherein said sintered polycrystalline GaN has surfaces that are substantially smooth, with a root-mean-square roughness below about 20 μm.
- 20 26. The method of claim 18, wherein said GaN enclosed in said container is a powder.
 - The method of claim 18, wherein said GaN enclosed in said container is a cold-pressed bill.